

Features

- Hybrid 6-pin package
- 1500Vdc isolation voltage
- High Speed 1MHz
- Small package outline
- High reliability and rugged construction
- High reliability screening available
- Radiation tolerant
- Open collector output
- Operating temperature range -55℃ to +125℃

Applications

- Switch mode power supplies
- Computer peripheral interface
- Motor control
- Ground signal isolation

Description

The IBI300 consists of a phototransistor optically coupled to an AlGaAs infrared-emitting diode in a leadless hybrid surface mount package.

Schematic Diagram

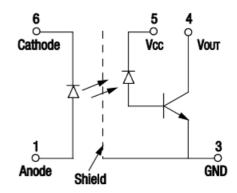


Figure 1. IBI300 Schematic Diagram

Package Dimensions in inches (mm)

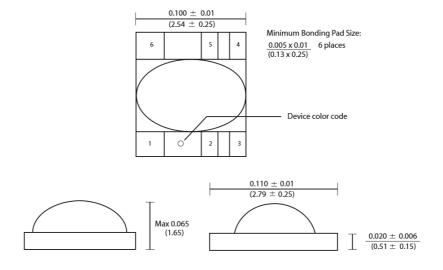


Figure 2. IBI300 Package Dimensions

Absolute Maximum Rating at 25°C (Note 1)

Symbol	Parameters	Ratings	Units	Notes
VDC	Isolation voltage	-1500 to +1500	V	2
Topr	Operating temperature	-55 to +125	۰C	
Tstg	Storage temperature	-65 to +150	۰C	
Tsol	Soldering temperature (10 seconds maximum)	240	°C	
Emitter				
P _D	Emitter power dissipation	36	mW	
l _F	Forward current	20	mA	
I _{F(TRANS)}	Peak transient current (≤1ms P.W.)	40	mA	
VR	Reverse voltage	5	V	
Detector				
P _D	Detector power dissipation	50	mW	3
lo	Output Current	8	mA	
I _{O(PEAK)}	Peak Output Current	16	mA	
Vcc	Supply Voltage	-0.5 to +18.0	V	
Vo	Output Voltage	-0.5 to +18.0	V	

Notes

ESD Precaution

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).

^{1.} When using this product, please observe the absolute maximum ratings. Only one parameter may be set at the limit to ensure no damage to the device. Exceeding any of the limits listed here may damage the device.

^{2.} Measured between input pins 1 and 6 shorted together, and output pins 2, 3, 4, and 5 shorted together. T_A = 25°C and duration = 1sec.

^{3.} Linear derating factor: 1.4 mW/°C above 100°C

Electrical Characteristics $T_A = -55\%$ to +125% (unless otherwise specified) (Note 1)

Emitter Characteristics

	Symbol	Parameters	Test Conditions	Min	Тур	Мах	Units	Notes
	V_{F}	Forward Voltage	I _F =10mA	-	1.8	2.5	V	
Ī	B _{VR}	Input Breakdown Reverse Voltage	I _R =10µA	3	-	-	V	

Detector Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Мах	Units	Notes
Vol	Logic Low Output Voltage	I _F =10mA,I _{OL} =1.5mA,V _{CC} =4.5V	-	0.15	0.4	V	
I _{OH}	Logic High Output Current	I _F =0mA, V _{CC} =15V, V _O =15V	-	0.05	100.0	μΑ	
Iccl	Logic Low Supply Current	I _F =10mA, V _{CC} =15V, V _O =open	-	40	200	μA	
Іссн	Logic High Supply Current	I _F =0mA, V _{CC} =15V, V _O =open	-	0.05	10	μΑ	

Transfer Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Мах	Units	Notes
CTR	Current Transfer Ratio	I _F =10mA, V _{CC} =4.5V, V _O =0.4V	15	25	-	%	2
lio	Input to Output Leakage Current	V_{IO} = 1500 V_{DC} Relative Humidity \leq 50% T_A =25° C	-	-	1	μА	3

Propagation Delay Time

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
t _{PHL}	Logic High to Low	I _F = 10mA, V _{CC} = 5V,	-	0.3	1.0	us	4
t _{PLH}	Logic Low to High	R _L = 4.1kΩ, T _A =25°C	-	0.5	2.0	μο	4

Notes

- 1. Performance guaranteed only under conditions listed in above tables.
- 2. CTR is the ratio of the output collector current I_{C_ON} to the forward LED current I_F multiplied by 100%
- 3. Measured between input pins 1 and 6 shorted together, and output pins 2, 3, 4, and 5 shorted together. T_A = 25°C and duration = 1sec.
- 4. A ceramic bypass capacitor $(0.01\mu F$ to $0.1\mu F)$ between pins 3 and 5 is required to stabilize the operation of the amplifier.

Typical Characteristic Curves

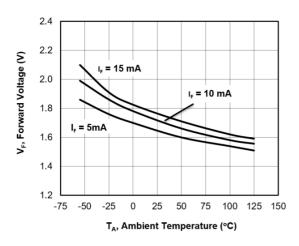


Figure 3. Forward Voltage vs Temperature

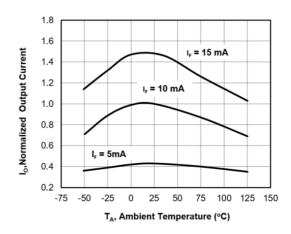


Figure 4. Output Current vs Temperature

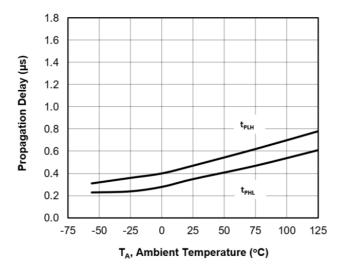


Figure 5. Propagation Delay vs Temperature

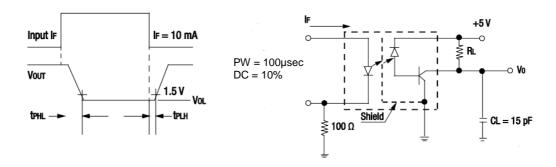


Figure 6. IBI300 Switching Test Circuit



IBI300

Ordering Information

Manufacturing Part Number	Part Description			
IBI300	Radiation Tolerant High-Speed 1MHz 6-pin Hybrid Package			

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